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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	12
Program Memory Size	768B (512 x 12)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	25 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	20-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c54c-20i-ss

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Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

TABLE 1-1: PIC16C5X FAMILY OF DEVICES

Features	PIC16C54	PIC16CR54	PIC16C55	PIC16C56	PIC16CR56		
Maximum Operation Frequency	40 MHz	20 MHz	40 MHz	40 MHz	20 MHz		
EPROM Program Memory (x12 words)	512	—	512	1K	—		
ROM Program Memory (x12 words)	—	512	—	—	1K		
RAM Data Memory (bytes)	25	25	24	25	25		
Timer Module(s)	TMR0	TMR0	TMR0	TMR0	TMR0		
I/O Pins	12	12	20	12	12		
Number of Instructions	33	33	33	33	33		
Packages	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP	28-pin DIP, SOIC; 28-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP		
All PIC [®] Family devices have Power-on Reset, selectable Watchdog Timer, selectable Code Protect and high I/O current capability.							

PIC16C58 Features **PIC16C57** PIC16CR57 PIC16CR58 Maximum Operation Frequency 20 MHz 40 MHz 40 MHz 20 MHz EPROM Program Memory (x12 words) 2K 2K ____ _ ROM Program Memory (x12 words) 2K 2K _ _ RAM Data Memory (bytes) 72 72 73 73 Timer Module(s) TMR0 TMR0 TMR0 TMR0 I/O Pins 20 20 12 12 Number of Instructions 33 33 33 33 28-pin DIP, SOIC; 28-pin DIP, SOIC; 18-pin DIP, SOIC; 18-pin DIP, SOIC; Packages 28-pin SSOP 28-pin SSOP 20-pin SSOP 20-pin SSOP All PIC® Family devices have Power-on Reset, selectable Watchdog Timer, selectable Code Protect and high I/O current capability.

	Pi	n Numb	er	Pin	Buffer	
Pin Name	DIP	SOIC	SSOP	Туре	Туре	Description
RA0	17	17	19	I/O	TTL	Bi-directional I/O port
RA1	18	18	20	I/O	TTL	
RA2	1	1	1	I/O	TTL	
RA3	2	2	2	I/O	TTL	
RB0	6	6	7	I/O	TTL	Bi-directional I/O port
RB1	7	7	8	I/O	TTL	
RB2	8	8	9	I/O	TTL	
RB3	9	9	10	I/O	TTL	
RB4	10	10	11	I/O	TTL	
RB5	11	11	12	I/O	TTL	
RB6	12	12	13	I/O	TTL	
RB7	13	13	14	I/O	TTL	
TOCKI	3	3	3	I	ST	Clock input to Timer0. Must be tied to Vss or VDD, if not in use, to reduce current consumption.
MCLR/Vpp	4	4	4	I	ST	Master clear (RESET) input/programming voltage input. This pin is an active low RESET to the device. Voltage on the MCLR/VPP pin must not exceed VDD to avoid unin- tended entering of Programming mode.
OSC1/CLKIN	16	16	18	I	ST	Oscillator crystal input/external clock source input.
OSC2/CLKOUT	15	15	17	0		Oscillator crystal output. Connects to crystal or resonator in crystal Oscillator mode. In RC mode, OSC2 pin outputs CLKOUT, which has 1/4 the frequency of OSC1 and denotes the instruction cycle rate.
Vdd	14	14	15,16	Р	_	Positive supply for logic and I/O pins.
Vss	5	5	5,6	Р	_	Ground reference for logic and I/O pins.

TABLE 3-1:PINOUT DESCRIPTION - PIC16C54, PIC16CR54, PIC16C56, PIC16CR56, PIC16CR58,
PIC16CR58

Legend: I = input, O = output, I/O = input/output, P = power, — = Not Used, TTL = TTL input, ST = Schmitt Trigger input

NOTES:

6.0 MEMORY ORGANIZATION

PIC16C5X memory is organized into program memory and data memory. For devices with more than 512 bytes of program memory, a paging scheme is used. Program memory pages are accessed using one or two STATUS Register bits. For devices with a data memory register file of more than 32 registers, a banking scheme is used. Data memory banks are accessed using the File Selection Register (FSR).

6.1 Program Memory Organization

The PIC16C54, PIC16CR54 and PIC16C55 have a 9bit Program Counter (PC) capable of addressing a 512 x 12 program memory space (Figure 6-1). The PIC16C56 and PIC16CR56 have a 10-bit Program Counter (PC) capable of addressing a 1K x 12 program memory space (Figure 6-2). The PIC16CR57, PIC16C58 and PIC16CR58 have an 11-bit Program Counter capable of addressing a 2K x 12 program memory space (Figure 6-3). Accessing a location above the physically implemented address will cause a wraparound.

A NOP at the RESET vector location will cause a restart at location 000h. The RESET vector for the PIC16C54, PIC16CR54 and PIC16C55 is at 1FFh. The RESET vector for the PIC16C56 and PIC16CR56 is at 3FFh. The RESET vector for the PIC16C57, PIC16CR57, PIC16C58, and PIC16CR58 is at 7FFh. See Section 6.5 for additional information using CALL and GOTO instructions.

FIGURE 6-1: PIC16C54/CR54/C55 PROGRAM MEMORY MAP AND STACK



FIGURE 6-2:

PIC16C56/CR56 PROGRAM MEMORY MAP AND STACK



FIGURE 6-3:

PIC16C57/CR57/C58/ CR58 PROGRAM MEMORY MAP AND STACK



PIC16C5X

XORLW Exclusive OR literal with W								
Syntax:	[<i>label</i>]	XORLW	k					
Operands:	$0 \leq k \leq 255$							
Operation:	(W) .XOR. $k \rightarrow (W)$							
Status Affected:	oted: Z							
Encoding:	1111	kkkk	kkkk					
Description:	The contents of the W register an XOR'ed with the eight bit literal 'I The result is placed in the W reg ter.							
Words:	1							
Cycles:	1							
Example:	XORLW	0xAF						
Before Instruction W = 0xB5 After Instruction W = 0x1A								

XORWF Exclusive OR W with f							
Syntax:	[label]	XORWF	f,d				
Operands:	$0 \le f \le 3$ $d \in [0, 1]$	31]					
Operation:	(W) .XOR. (f) \rightarrow (dest)						
Status Affected:	Status Affected: Z						
Encoding:	0001	10df	ffff				
Description:	Cription: Exclusive OR the contents of tr W register with register 'f'. If 'd' i the result is stored in the W reg ter. If 'd' is 1 the result is stored back in register 'f'.						
Words:	1						
Cycles:	1						
Example	XORWF	REG,1					
Before Instru	ction						
REG	= (0xAF					
W	= (0xB5					
After Instruct	ion						
REG	=	0x1A					
W	= (0xB5					

11.8 MPLAB ICD In-Circuit Debugger

Microchip's In-Circuit Debugger, MPLAB ICD, is a powerful, low cost, run-time development tool. This tool is based on the FLASH PIC MCUs and can be used to develop for this and other PIC microcontrollers. The MPLAB ICD utilizes the in-circuit debugging capability built into the FLASH devices. This feature, along with Microchip's In-Circuit Serial ProgrammingTM protocol, offers cost-effective in-circuit FLASH debugging from the graphical user interface of the MPLAB Integrated Development Environment. This enables a designer to develop and debug source code by watching variables, single-stepping and setting break points. Running at full speed enables testing hardware in real-time.

11.9 PRO MATE II Universal Device Programmer

The PRO MATE II universal device programmer is a full-featured programmer, capable of operating in Stand-alone mode, as well as PC-hosted mode. The PRO MATE II device programmer is CE compliant.

The PRO MATE II device programmer has programmable VDD and VPP supplies, which allow it to verify programmed memory at VDD min and VDD max for maximum reliability. It has an LCD display for instructions and error messages, keys to enter commands and a modular detachable socket assembly to support various package types. In Stand-alone mode, the PRO MATE II device programmer can read, verify, or program PIC devices. It can also set code protection in this mode.

11.10 PICSTART Plus Entry Level Development Programmer

The PICSTART Plus development programmer is an easy-to-use, low cost, prototype programmer. It connects to the PC via a COM (RS-232) port. MPLAB Integrated Development Environment software makes using the programmer simple and efficient.

The PICSTART Plus development programmer supports all PIC devices with up to 40 pins. Larger pin count devices, such as the PIC16C92X and PIC17C76X, may be supported with an adapter socket. The PICSTART Plus development programmer is CE compliant.

11.11 PICDEM 1 Low Cost PIC MCU Demonstration Board

The PICDEM 1 demonstration board is a simple board which demonstrates the capabilities of several of Microchip's microcontrollers. The microcontrollers supported are: PIC16C5X (PIC16C54 to PIC16C58A). PIC16C61, PIC16C62X, PIC16C71, PIC16C8X, PIC17C42, PIC17C43 and PIC17C44. All necessary hardware and software is included to run basic demo programs. The user can program the sample microcontrollers provided with the PICDEM 1 demonstration board on a PRO MATE II device programmer, or a PICSTART Plus development programmer, and easily test firmware. The user can also connect the PICDEM 1 demonstration board to the MPLAB ICE incircuit emulator and download the firmware to the emulator for testing. A prototype area is available for the user to build some additional hardware and connect it to the microcontroller socket(s). Some of the features include an RS-232 interface, a potentiometer for simulated analog input, push button switches and eight LEDs connected to PORTB.

11.12 PICDEM 2 Low Cost PIC16CXX Demonstration Board

The PICDEM 2 demonstration board is a simple demonstration board that supports the PIC16C62, PIC16C64, PIC16C65, PIC16C73 and PIC16C74 microcontrollers. All the necessary hardware and software is included to run the basic demonstration programs. The user can program the sample microcontrollers provided with the PICDEM 2 demonstration board on a PRO MATE II device programmer, or a PICSTART Plus development programmer, and easily test firmware. The MPLAB ICE in-circuit emulator may also be used with the PICDEM 2 demonstration board to test firmware. A prototype area has been provided to the user for adding additional hardware and connecting it to the microcontroller socket(s). Some of the features include a RS-232 interface, push button switches, a potentiometer for simulated analog input, a serial EEPROM to demonstrate usage of the I^2C^{TM} bus and separate headers for connection to an LCD module and a keypad.

12.7 Timing Diagrams and Specifications



FIGURE 12-2: EXTERNAL CLOCK TIMING - PIC16C54/55/56/57

TABLE 12-1: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16C54/55/56/57

Standard Operating Conditions (unless otherwise specified)								
AC Characteristics		Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ for commercial						
		$-40^{\circ}C \le TA \le +85^{\circ}C$ for industri						
		-40)°C ≤ 1	「A ≤ +125	°C for ex	tended		
Param No.	Symbol	Characteristic	Min	Тур†	Max	Units	Conditions	
1A	Fosc	External CLKIN Frequency ⁽¹⁾	DC		4.0	MHz	XT OSC mode	
			DC	—	10	MHz	10 MHz mode	
			DC	—	20	MHz	HS OSC mode (Comm/Ind)	
			DC	—	16	MHz	HS OSC mode (Ext)	
			DC	—	40	kHz	LP OSC mode	
		Oscillator Frequency ⁽¹⁾	DC	—	4.0	MHz	RC OSC mode	
			0.1	—	4.0	MHz	XT OSC mode	
			4.0	—	10	MHz	10 MHz mode	
			4.0	—	20	MHz	HS OSC mode (Comm/Ind)	
			4.0	—	16	MHz	HS OSC mode (Ext)	
			DC	_	40	kHz	LP osc mode	

* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.

2: Instruction cycle period (TCY) equals four times the input oscillator time base period.



FIGURE 13-4: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER TIMING - PIC16CR54A

TABLE 13-3: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER - PIC16CR54A

AC Chara	$ \begin{array}{c} \mbox{Standard Operating Conditions (unless otherwise specified)} \\ \mbox{Operating Temperature} & 0^{\circ}C \leq TA \leq +70^{\circ}C \mbox{ for commercial} \\ -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for industrial} \\ -40^{\circ}C \leq TA \leq +125^{\circ}C \mbox{ for extended} \end{array} $						
Param No.	Symbol	Characteristic	Min	Тур†	Max	Units	Conditions
30	TmcL	MCLR Pulse Width (low)	1.0*	_	_	μS	VDD = 5.0V
31	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7.0*	18*	40*	ms	VDD = 5.0V (Comm)
32	Tdrt	Device Reset Timer Period	7.0*	18*	30*	ms	VDD = 5.0V (Comm)
34	Tioz	I/O Hi-impedance from MCLR Low	_	_	1.0*	μS	

These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 14-6: MAXIMUM IPD vs. VDD, WATCHDOG DISABLED



FIGURE 14-7: TYPICA

TYPICAL IPD vs. VDD, WATCHDOG ENABLED



FIGURE 14-8: MAXIMUM IPD vs. VDD, WATCHDOG ENABLED



IPD, with WDT enabled, has two components: The leakage current, which increases with higher temperature, and the operating current of the WDT logic, which increases with lower temperature. At -40° C, the latter dominates explaining the apparently anomalous behavior.

15.6 Timing Diagrams and Specifications

FIGURE 15-2: EXTERNAL CLOCK TIMING - PIC16C54A



TABLE 15-1:	EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16C54A

AC Chara	acteristics	$ \begin{array}{ll} \mbox{Standard Operating Conditions (unless otherwise specified)} \\ \mbox{Operating Temperature} & 0^{\circ}C \leq TA \leq +70^{\circ}C \mbox{ for commercial} \\ -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for industrial} \\ -20^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for industrial} - PIC16LV54A-02I \\ -40^{\circ}C \leq TA \leq +125^{\circ}C \mbox{ for extended} \\ \end{array} $						
Param No.	Symbol	Characteristic Min Typ† Max Units Conditions						
	Fosc	External CLKIN Fre-	DC		4.0	MHz	XT OSC mode	
		quency ⁽¹⁾	DC	—	2.0	MHz	XT osc mode (PIC16LV54A)	
			DC	—	4.0	MHz	HS osc mode (04)	
			DC	—	10	MHz	HS osc mode (10)	
			DC	—	20	MHz	HS osc mode (20)	
			DC	—	200	kHz	LP osc mode	
		Oscillator Frequency ⁽¹⁾	DC	_	4.0	MHz	RC osc mode	
			DC	—	2.0	MHz	RC osc mode (PIC16LV54A)	
			0.1	—	4.0	MHz	XT osc mode	
			0.1	—	2.0	MHz	XT osc mode (PIC16LV54A)	
			4.0	—	4.0	MHz	HS osc mode (04)	
			4.0	—	10	MHz	HS osc mode (10)	
			4.0	—	20	MHz	HS osc mode (20)	
			5.0		200	kHz	LP osc mode	

* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

- Note 1: All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.
 - Instruction cycle period (TcY) equals four times the input oscillator time base period.

16.0 DEVICE CHARACTERIZATION - PIC16C54A

The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

"Typical" represents the mean of the distribution at 25°C. "Maximum" or "minimum" represents (mean + 3σ) or (mean - 3σ) respectively, where σ is a standard deviation, over the whole temperature range.



FIGURE 16-1: TYPICAL RC OSCILLATOR FREQUENCY vs. TEMPERATURE

TABLE 16-1: RC OSCILLATOR FREQUENCIES

Сехт	Rext	Average Fosc @ 5 V, 25°C				
20 pF	3.3K	5 MHz	± 27%			
	5K	3.8 MHz	± 21%			
	10K	2.2 MHz	± 21%			
	100K	262 kHz	± 31%			
100 pF	3.3K	1.6 MHz	± 13%			
	5K	1.2 MHz	± 13%			
	10K	684 kHz	± 18%			
	100K	71 kHz	± 25%			
300 pF	3.3K	660 kHz	± 10%			
	5.0K	484 kHz	± 14%			
	10K	267 kHz	± 15%			
	100K	29 kHz	± 19%			

The frequencies are measured on DIP packages.

The percentage variation indicated here is part-to-part variation due to normal process distribution. The variation indicated is ± 3 standard deviation from average value for VDD = 5V.



FIGURE 16-10: TYPICAL IDD vs. FREQUENCY (WDT DISABLED, RC MODE @ 20 PF, 25°C)

FIGURE 16-11: MAXIMUM IDD vs. FREQUENCY (WDT DISABLED, RC MODE @ 20 PF, -40°C to +85°C)



17.1 DC Characteristics:PIC16C54C/C55A/C56A/C57C/C58B-04, 20 (Commercial, Industrial) PIC16LC54C/LC55A/LC56A/LC57C/LC58B-04 (Commercial, Industrial) PIC16CR54C/CR56A/CR57C/CR58B-04, 20 (Commercial, Industrial) PIC16LCR54C/LCR56A/LCR57C/LCR58B-04 (Commercial, Industrial)

PIC16LC5X PIC16LCR5X (Commercial, Industrial) PIC16C5X PIC16CR5X (Commercial, Industrial)									
Param No.	Symbol	Characteristic/Device	Min	Тур†	Max	Conditions			
	Vdd	Supply Voltage							
D001		PIC16LC5X	2.5 2.7 2.5		5.5 5.5 5.5	V V V	$\begin{array}{l} -40^{\circ}C \leq TA \leq +\ 85^{\circ}C,\ 16LCR5X \\ -40^{\circ}C \leq TA \leq 0^{\circ}C,\ 16LC5X \\ 0^{\circ}C \leq TA \leq +\ 85^{\circ}C \ 16LC5X \end{array}$		
D001A		PIC16C5X	3.0 4.5		5.5 5.5	V V	RC, XT, LP and HS mode from 0 - 10 MHz from 10 - 20 MHz		
D002	Vdr	RAM Data Retention Volt- age ⁽¹⁾	-	1.5*	-	V	Device in SLEEP mode		
D003	VPOR	VDD Start Voltage to ensure Power-on Reset	_	Vss	—	V	See Section 5.1 for details on Power-on Reset		
D004	SVDD	VDD Rise Rate to ensure Power-on Reset	0.05*	—	_	V/ms	See Section 5.1 for details on Power-on Reset		

Legend: Rows with standard voltage device data only are shaded for improved readability.

* These parameters are characterized but not tested.

- † Data in "Typ" column is at 5V, 25°C, unless otherwise stated. These parameters are for design guidance only, and are not tested.
- Note 1: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern and temperature also have an impact on the current consumption.
 - a) The test conditions for all IDD measurements in active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to Vss, T0CKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
 - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode. The power-down current in SLEEP mode does not depend on the oscillator type.
 - **3:** Does not include current through REXT. The current through the resistor can be estimated by the formula: IR = VDD/2REXT (mA) with REXT in k Ω .



FIGURE 18-2: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD, CEXT = 20 PF, 25°C









28-Lead Skinny Plastic Dual In-line (SP) - 300 mil (PDIP)





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	Units	INCHES*		MILLIMETERS			
Dimension L	imits	MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		28			28	
Pitch	р		.100			2.54	
Top to Seating Plane	Α	.140	.150	.160	3.56	3.81	4.06
Molded Package Thickness	A2	.125	.130	.135	3.18	3.30	3.43
Base to Seating Plane	A1	.015			0.38		
Shoulder to Shoulder Width	Е	.300	.310	.325	7.62	7.87	8.26
Molded Package Width	E1	.275	.285	.295	6.99	7.24	7.49
Overall Length	D	1.345	1.365	1.385	34.16	34.67	35.18
Tip to Seating Plane	L	.125	.130	.135	3.18	3.30	3.43
Lead Thickness	С	.008	.012	.015	0.20	0.29	0.38
Upper Lead Width	B1	.040	.053	.065	1.02	1.33	1.65
Lower Lead Width	В	.016	.019	.022	0.41	0.48	0.56
Overall Row Spacing §	eB	.320	.350	.430	8.13	8.89	10.92
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

* Controlling Parameter § Significant Characteristic

eВ

Dimension D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed

.010" (0.254mm) per side.

JEDEC Equivalent: MO-095

Drawing No. C04-070

- p -

Notes:

APPENDIX A: COMPATIBILITY

To convert code written for PIC16CXX to PIC16C5X, the user should take the following steps:

- 1. Check any CALL, GOTO or instructions that modify the PC to determine if any program memory page select operations (PA2, PA1, PA0 bits) need to be made.
- 2. Revisit any computed jump operations (write to PC or add to PC, etc.) to make sure page bits are set properly under the new scheme.
- 3. Eliminate any special function register page switching. Redefine data variables to reallocate them.
- 4. Verify all writes to STATUS, OPTION, and FSR registers since these have changed.
- 5. Change RESET vector to proper value for processor used.
- 6. Remove any use of the ADDLW, RETURN and SUBLW instructions.
- 7. Rewrite any code segments that use interrupts.

APPENDIX B: REVISION HISTORY

Revision KE (January 2013)

Added a note to each package outline drawing.

PIC16C5X

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High-Performance RISC CPU	1
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Dev	vice: PIC16C5X Literatur	e Number: DS30453E				
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PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	· <u>xx </u>	<u>/xx</u>	<u>xxx</u>	Examples:
Device	Frequency Temperatu Range/OSC Range Type	e Package	Pattern	 a) PIC16C55A - 04/P 301 = Commercial Temp., PDIP package, 4 MHz, standard VDD limits, QTP pattern #301 b) PIC16I C5C _ 04/ISO ladustrial Temp. SOIC
Device Frequency Range/ Oscillator Type	PIC16C54 PIC16C55 PIC16C54A PIC16C5 PIC16CR54A PIC16C5 PIC16C55 PIC16C5 PIC16C55 PIC16C5 PIC16C56A PIC16C5 PIC16C55 PIC16C55 PIC16C56A PIC16C56 PIC16C56A PIC16C57 PIC16C57C PIC16C57 PIC16C57C PIC16C57 PIC16C57C PIC16C57 PIC16C57C PIC16C57 PIC16C57B PIC16C57 PIC16C57C PIC16C57 PIC16C57B PIC16C58B PIC16C58B PIC16C57 PIC16C58	$\begin{array}{c} 4T^{(2)} \\ 4AT^{(2)} \\ 54AT^{(2)} \\ 54CT^{(2)} \\ 54CT^{(2)} \\ 55T^{(2)} \\ 55T^{(2)} \\ 56AT^{(2)} \\ 56AT^{(2)} \\ 56AT^{(2)} \\ 77C1^{(2)} \\ 57CT^{(2)} \\ 57CT^{(2)} \\ 58BT^{(2)} \end{array}$		 b) PIC 16LC34C - 04/SO Industrial temp., SOIC package, 200 kHz, extended VDD limits c) PIC16C57 - RC/SP = RC Oscillator, commercial temp, skinny PDIP package, 4 MHz, standard VDD limits d) PIC16C58BT -40/SS 123 = commercial temp, SSOP package in tape and reel, 4 MHz, extended VDD limits, ROM pattern #123 Note 1: C = normal voltage range LC = extended 2: T = in tape and reel - SOIC and SSOP packages only 3: JW Devices are LIV erasable and can be
	 XT Standard Crystal/Resonatc High Speed Crystal 200 KHz (LP) or 2 MHz (X' 400 KHz (LP) or 4 MHz (X' 10 MHz (HS only) 20 MHz (HS only) 40 MHz (HS only) 40 MHz (HS only) 50 xoillator type for JW pi *RC/LP/XT/HS are for 16C54/55 •02 is available for 16LV54A onl •40 is available for 16C54C/55A 	and RC) and RC) ckages ⁽³⁾ /56/57 devices onl / or all other device: 56A/57C/58B devi	ly s ices only	 programmed to any device configura- tion. JW Devices meet the electrical requirements of each oscillator type, including LC devices. 4: b = Blank
Temperature Range	$b^{(4)} = 0^{\circ}C \text{ to } +70^{\circ}C \\ I = -40^{\circ}C \text{ to } +85^{\circ}C \\ E = -40^{\circ}C \text{ to } +125^{\circ}C \\ \end{array}$			
Package	S = Die in Waffle Pack JW = 28-pin 600 mil/18-pin DIP(3) P = 28-pin 600 mil/18-pin SO = 300 mil SOIC SS SS = 209 mil SSOP SP SP = 28-pin 300 mil Skinny *See Section 21 for additional p *	300 mil windowed 300 mil PDIP PDIP ackage information	I CER-	
Pattern	QTP, SQTP, ROM code (factory Requirements. Blank for OTP and	specified) or Spec d Windowed devic	ial ces.	

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Data Sheets

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